

MD256128A6W-FPTLW 256 x 128		LCD Module				
	Specification					
Version: 1		Date: 30/07/2020				
		Revision				
1	29/07/2020					

Display	Features		
Resolution	256 x 128		
Appearance	Black on White		
Logic Voltage	3.3V		
Interface	I ² C, Parallel, SPI		COHS
Font Set	N/A		CoHS
Display Mode	Transflective		omphant
LC Type	FSTN		
Module Size	9 <mark>3</mark> .00 x 54.00 x 9.50 mm		
Operating Temperature	-20°C ~ +70°C		
Construction	СОВ	Box Quantity	Weight / Display
LED Backlight	White		
aesigi	n • manufactu	ire su	ppty

* - For full design functionality, please use this specification in conjunction with the ST75256 specification.(Provided Separately)

Display Accessories					
Part Number	Description				

Optional Variants						
Appearances	Voltage					

General Specification

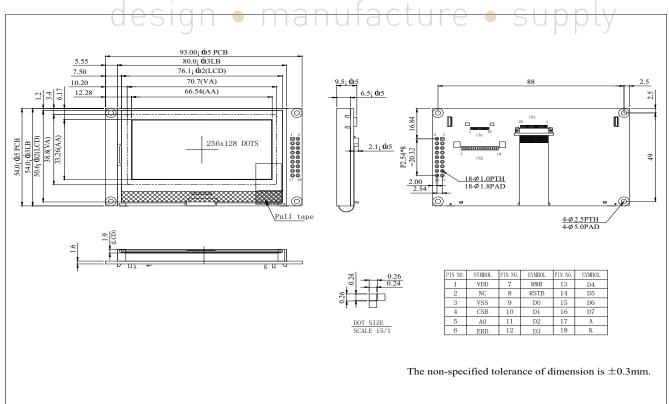
The Features is described as follow:

- Number of dots: 256 x 128
- Module dimension: 93.0 x 54.0 x 9.5 mm
- View area: 70.7 x 38.8 mm
- Active area: 66.54 x 33.26 mm
- Dot size: 0.24 x 0.24 mm
- Dot pitch: 0.26 x 0.26 mm
- LCD type: FSTN Positive Transflective
- Drive Method: 1/128 Duty,1/12 Bias
- View direction: 6 o'clock
- Backlight Type: LED, White
- IC: ST75256

Interface Pin Function

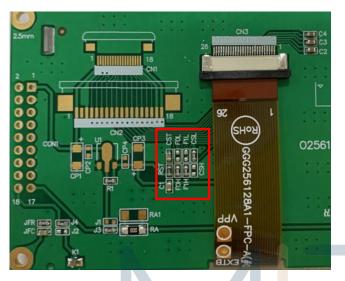
Pin No.	Symbol	Description
1	VDD	+3.3V
2	NC	No connection
3	VSS	ground
4	CSB	Chip select input pin
5	A0	Whether the access is related to data or command
6	ERD	Read or write enable terminal
7	RWR	Read/Write execution control pin
8	RSTB	Reset input pin
9~16	D0~D7	Data bus line
17	A	LED+
18	к	LED-

Contour Drawing



For Different Interface

The module is 8080 PARALLEL at default. If you want to change the interface to SPI or I²C, you could refer to the following **F0H/F0L**, **F1H/F1L** jumper links to change the resistors accordingly.



Setting Serial Interface

Interface	CSB	AO	ERD	RWR	D[7:0]			
4-Line SPI	CSB	AO			D[0]= SCL, D[1:3]=SDA, D[4:7]=			
3-Line SPI	CSB	-			D[0]= SCL, D[1:3]=SDA, D[4:7]=			
I ² C interface				ma 	D[0]=SCL, D1=SDA_IN, D[3:2]=SDA_OUT, D[5:4]=, D[7:6]=SA[1:0]. Refer to I ² C interface.			

The un-used pins are marked as "---" and should be fixed to "H" by VDD1.

These pins select interface operation mode.					
IF1	IF0	MPU interface type			
L	L	4-line serial interface			
L	Н	I ² C serial interface			
Н	L	8-bit 6800 parallel interface			
Н	Н	8-bit 8080 parallel interface			

Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0	_	30	ψ= 180°
	θ	CR≧2	0	_	60	ψ= 0°
	θ	CR≧2	0	_	45	ψ= 90°
	θ	CR≧2	0	_	45	ψ= 270°
Contrast Ratio	CR			5		_
	T rise		_	200	300	ms
Response Time	T fall		_	250	350	ms

Definition of Operation Voltage (Vop)



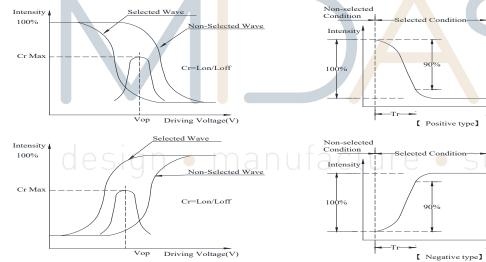
Non-selected Condition

-Tf-

Τf

Non-selected Condition 10%

10%

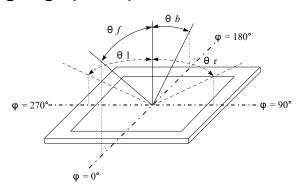


Conditions :

Operating Voltage : Vop

Viewing Angle(θ , ϕ) : 0° , 0°

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias **Definition of viewing angle(CR≧2)**



Absolute Maximum Ratings

Item	Symbol	Min	Тур	Мах	Unit
Operating Temperature	Тор	-20	—	+70	°C
Storage Temperature	Тѕт	-30	_	+80	°C
MPU Interface Input Voltage	Vin	-0.3	_	V _{DD} +0.3	V
Digital Power Supply Voltage	V _{DD} -Vss	-0.3	_	4.0	V
LCD Power supply voltage	V0- XV0	-0.3	_	19.0	V

Electrical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	Vdd-Vs <mark>s</mark>	-	3.0	3.3	3.6	V
		Ta=-20 ℃	_	_	_	V
Supply Voltage For LCM		Ta=25℃	14.2	14.5	14.8	oly
		Ta=70 ℃	—	—	_	V
Input High Volt.	VIH	_	$0.7 V_{DD}$	_	V _{DD}	V
Input Low Volt.	VIL	_	Vss	_	$0.3 V_{DD}$	V
Output High Volt.	V _{OH}	_	0.8 V _{DD}		V _{DD}	V
Output Low Volt.	Vol	_	Vss		0.2 V _{DD}	V
Supply Current	ldd	V _{DD} =3.3V	_	1.5	2.0	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

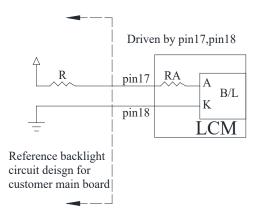
Backlight Information

Specification

PARAMETER	SYMBOL	MIN	ТҮР	МАХ	UNIT	TEST CONDITION
Supply Current	ILED	_	96	120	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	v	_
Reverse Voltage	VR	_	_	5	v	_
Luminance (Without LCD)	IV	840	1050	_	CD/M ²	ILED=96mA
LED Life Time						ILED=96mA
(For Reference	-		50K	-	Hr.	25℃,50-60%RH,
only)						(Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.



Reliability

Content of Reliability Test (Wide temperature, -20℃~70℃)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times	

Note1: No dew condensation to be observed.

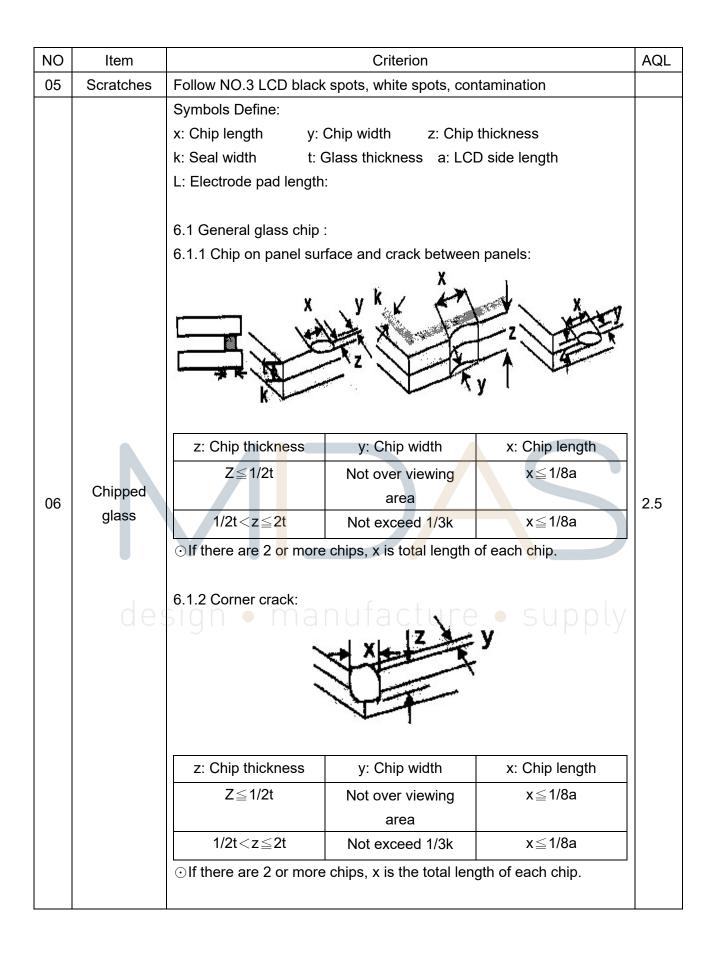
Note2: The function test shall be conducted after 4 hours storage at the normal

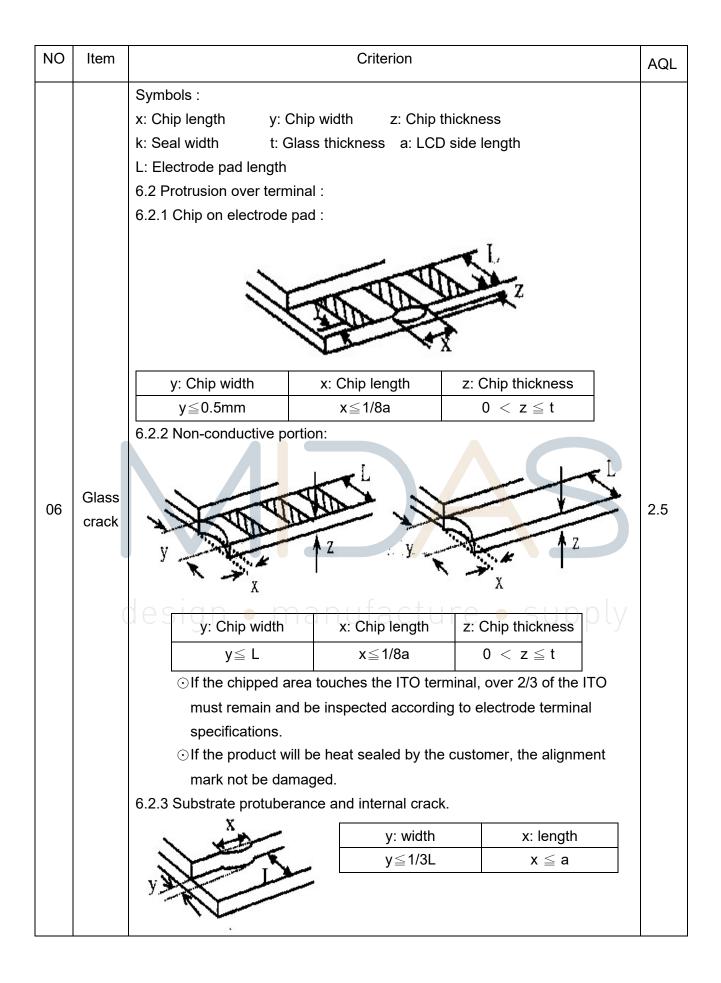
Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Inspection specification

NO	Item	Criterion						
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 						
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 						
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y) / 2$ $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0	2.5				
		3.2 Line type : (As following drawing) 	- 2	2.5				
04	Polarizer bubbles	If bubbles are visible, judge using black spotSize Φ judge using black spot $\Phi \leq 0.20$ specifications, not easy to find, must check in specify direction. $0.20 < \Phi \leq 0.50$ $0.50 < \Phi \leq 1.00$ $1.00 < \Phi$ Total Q TY		2.5				





NO	Item	Criterion			
07	Cracked glass	The LCD with extensive crack is not acceptable.			
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 			
09	Bezel	 9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications. 			
10	PCB, COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production. 			
11	Soldering	Soldering11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.			

NO	Item	Criterion				
	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 				
		12.3 No contamination, solder residue or solder balls on product.	0.65 2.5			
		12.4 The IC on the TCP may not be damaged, circuits.	2.5			
		12.5 The uppermost edge of the protective strip on the interface	2.5			
		pin must be present or look as if it cause the interface pin to				
		sever.				
12		12.6 The residual rosin or tin oil of soldering (component or chip				
		component) is not burned into brown or black color.	2.5			
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65			
		12.8 Pin type must match type in specification sheet.	0.65			
		12.9 LCD pin loose or missing pins.	0.65			
		12.10 Product packaging must the same as specified on				
		packaging specification sheet. 12.11 Product dimension and structure must conform to product				
		12.12 Visual defect outside of VA is not considered to be rejection.				

design • manufacture • supply

Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

design • manufacture • supply

Material List of Components for RoHs

1. Midas Displays hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.										

2.Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow:250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.